HIGH-SPEED 3.3V 16/8K X 9 SYNCHRONOUS PIPELINED DUAL-PORT STATIC RAM

SPECIFIED PART IS OBSOLETE NOT RECOMMENDED FOR NEW DESIGNS

Features:

- True Dual-Ported memory cells which allow simultaneous access of the same memory location
- High-speed clock to data access
- Commercial: 6.5/7.5/9ns (max.)
- Industrial: 7.5ns (max.)
- Low-power operation
 - IDT70V916/59L/59L
 Active: 450mW (typ.)
 Standby: 1.5mW (typ.)
- Flow-Through or Pipelined output mode on either port via the FT/PIPE pins
- Counter enable and reset features
- Dual chip enables allow for depth expansion without additional logic

Functional Block Diagram

- Full synchronous operation on both ports
 - 3.5ns setup to clock and Ons hold on all control, data, and address inputs
 - Data input, address, and control registers
 - Fast 6.5ns clock to data out in the Pipelined output mode
 - Self-timed write allows fast cycle time
 - 10ns cycle time, 100MHz operation in Pipelined output mode
- Separate upper-byte and lower-byte controls for multiplexed bus and bus matching compatibility
- LVTTL- compatible, single 3.3V (±0.3V) power supply
- Industrial temperature range (-40°C to +85°C) is available for 83 MHz
- Available in a 100-pin Thin Quad Flatpack (TQFP) and 100pin fine pitch Ball Grid Array (fpBGA) packages.

Note that information regarding recently obsoleted parts is included in this datasheet for customer convenience.



NOTE:

1. A13 is a NC for IDT70V9159.

FEBRUARY 2018

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70V9169/59L

High-Speed 3.3V 16/8K x 9 Dual-Port Synchronous Pipelined Static RAM

Industrial and Commercial Temperature Ranges

Description:

The IDT70V9169/59 is a high-speed 16/8K x 9 bit synchronous Dual-Port RAM. The memory array utilizes Dual-Port memory cells to allow simultaneous access of any address from both ports. Registers on control, data, and address inputs provide minimal setup and hold times. The timing latitude provided by this approach allows systems to be designed with very short cycle times. With an input data register, the IDT70V9169/59 has been optimized for applications having unidirectional or bidirectional data flow in bursts. An automatic power down feature, controlled by \overline{CE}_0 and CE1, permits the on-chip circuitry of each port to enter a very low standby power mode. Fabricated using CMOS high-performance technology, these devices typically operate on only 450mW of power.

Pin Configurations^(1,2,3,4)



- 1. A13 is a NC for IDT70V9159.
- 2. All VDD pins must be connected to power supply.
- 3. All Vss pins must be connected to ground supply.
- 4. Package body is approximately 14mm x 14mm x 1.4mm.
- 5. This package code is used to reference the package diagram.
- 6. This text does not indicate orientation of the actual part-marking.

PinConfigurations(cont'd)^(1,2,3,4)

70V9169/59PF BF100⁽⁵⁾

100-Pin fpBGA Top View⁽⁶⁾

A1	a2	a3	A4	^{A5}	A6	A7	^{A8}	^{A9}	A10
A6R	A9r	A12R	NC	Vss	Vss	NC	R/WR	Vss	NC
B1 A4R	b2 A5r	B3 A8R	B4 A10R	^{B5} NC	B6 NC	^{B7} NC	B8 OEr	^{B9} NC	b10 I/O6r
С1	C2	C3	C4	^{C5}	C6	C7	C8	C9	С10
Азк	NC	NC	A7R	NC	CE0R	CE1R	PL/FTR	I/O7R	I/Oзr
D1	d2	d3	D4	d5	D6	D7	d8	d9	D10
Aor	CLKr	A1r	A2R	A11r	A13R ⁽¹⁾	CNTRSTR	I/O8r	I/O5r	I/O1R
E1	e2	E3	e4	e5	^{E6}	e7	e8	e9	e10
Vss	ADSr	CNTEN _R	A1l	ADSl	Vss	I/O4r	I/O2r	I/Oor	Vdd
F1	F2	F3	F4	f5	^{F6}	f7	f8	F9	F10
Vss	CLKL	Aol	A3L	Vdd	Vss	Vdd	I/O2l	I/O1L	I/Ool
G1	G2	G3	G4	G5	G6	G7	G8	^{G9}	G10
CNTEN∟	NC	A5L	A12L	NC	R∕₩L	NC	I/O4L	Vss	I/O3L
H1	H2	H3	H4	^{H5}	H6	^{H7} NC	h8	h9	h10
A2L	A4L	A9L	A13L ⁽¹⁾	NC	CE1L		I/O7l	I/O6l	I/O5l
J1	J2	J3	J4	J5	J6	J7	_{J8}	^{J9}	J10
NC	A7L	A10L	NC	NC	NC	OEL	Vss	Vss	I/O8L
K1	K2	кз	к4	k5	k6	K7	K8	ĸ9	к10
A6L	A8L	A11L	NC	Vdd	Vdd	CEol	CNTRST∟	PL/FT∟	NC

5655 drw 03

NOTES:

1. A13 is a NC for IDT70V9159.

- 2. All V_DD pins must be connected to power supply.
- 3. All Vss pins must be connected to ground supply.
- 4. Package body is approximately 10mm x 10mm x 1.4mm with 0.8mm ball pitch.
- 5. This package code is used to reference the package diagram.
- 6. This text does not indicate orientation of the actual part-marking.

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Pin Names

Left Port	Right Port	Names			
CEOL, CE1L	\overline{CE} OR, CE1R	Chip Enables			
R/WL	R/Wr	Read/Write Enable			
ŌĒL	0E r	Output Enable			
Aol - A13l ⁽¹⁾	Aor - A13r ⁽¹⁾	Address			
I/Ool - I/O8l	1/Oor - 1/O8r	Data Input/Output			
CLKL	CLKr	Clock			
ADSL	ADS R	Address Strobe			
	CNTEN R	Counter Enable			
		Counter Reset			
FT/PIPEL	FT /PIPER	Flow-Through/Pipeline			
V	DD	Power (3.3V)			
V	SS	Ground (0V)			

NOTE:

5655 tbl 01

1. A13 is a NC for IDT70V9159.

Truth Table I—Read/Write and Enable Control^(1,2,3)

ŌĒ	CLK	CE ₀	CE1	R/W	I/O0-8	Mode
Х	\uparrow	Н	Х	Х	High-Z	Deselected—Power Down
Х	\uparrow	Х	L	Х	High-Z	Deselected—Power Down
Х	\uparrow	L	Н	L	DATAIN	Write
L	\uparrow	L	Н	Н	DATAOUT	Read
Н	Х	L	Н	Х	High-Z	Outputs Disabled
						5655 tbl 02

NOTES:

1. "H" = VIH, "L" = VIL, "X" = Don't Care.

2. \overline{ADS} , \overline{CNTEN} , $\overline{CNTRST} = X$.

3. $\overline{\mathsf{OE}}$ is an asynchronous input signal.

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Industrial and Commercial Temperature Ranges

5655 tbl 03

5655 tbl 05

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Truth Table II—Address Counter Control^(1,2)

External Address	Previous Internal Address	Internal Address Used	CLK	ADS	CNTEN	CNTRST	I/O ⁽³⁾	MODE
An	Х	An	\uparrow	L ⁽⁴⁾	Х	Н	Dvo (n)	External Address Used
Х	An	An + 1	Ŷ	Н	L ⁽⁵⁾	Н	Dvo(n+1)	Counter Enabled—Internal Address generation
Х	An + 1	An + 1	\uparrow	Н	Н	Н	Dvo(n+1)	External Address Blocked—Counter disabled (An + 1 reused)
Х	Х	A0	\uparrow	Х	Х	L ⁽⁴⁾	Dvo(0)	Counter Reset to Address 0

NOTES:

3. Outputs configured in Flow-Through Output mode: if outputs are in Pipelined mode the data out will be delayed by one cycle.

4. ADS and CNTRST are independent of all other signals including CE0, CE1, UB and LB.

5. The address counter advances if CNTEN = VIL on the rising edge of CLK, regardless of all other signals including CE0, CE1, UB and LB.

Recommended Operating Temperature and Supply Voltage

Grade	Ambient Temperature ⁽¹⁾	GND	Vdd
Commercial	$0^{\circ}C$ to $+70^{\circ}C$	0V	3.3V <u>+</u> 0.3V
Industrial	-40°C to +85°C	0V	3.3V <u>+</u> 0.3V
			5655 tbl 04

NOTES:

1. This is the parameter TA. This is the "instant on" case temperature.

Recommended DC Operating Conditions

Symbol	Parameter	Min.	Тур.	Мах.	Unit
Vdd	Supply Voltage	3.0	3.3	3.6	V
Vss	Ground	0	0	0	V
ViH	Input High Voltage	2.0		VDD+0.3V ⁽²⁾	V
Vil	Input Low Voltage	-0.3(1)		0.8	V

NOTES:

1. $V_{IL} > -1.5V$ for pulse width less than 10 ns.

2. VTERM must not exceed VDD+0.3V.

Absolute Maximum Ratings⁽¹⁾

Symbol	Rating	Commercial & Industrial	Unit
Vterm ⁽²⁾	Terminal Voltage with Respect to GND	-0.5 to +4.6	V
Tbias	Temperature Under Bias	-55 to +125	٥C
Tstg	Storage Temperature	-65 to +150	٥C
Ιουτ	DC Output Current	50	mA
NOTES			5655 tbl 06

NOTES:

1. Stresses greater than those listed under ABSOLUTE MAXIMUM RATINGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

2. VTERM must not exceed VDD +0.3V for more than 25% of the cycle time or 10ns maximum, and is limited to \leq 20mA for the period of VTERM \geq VDD + 0.3V.

Capacitance⁽¹⁾ $(TA = +25^{\circ}C, f = 1.0MHz)$

Symbol	Parameter	Conditions ⁽²⁾	Max.	Unit	
Cin	Input Capacitance	VIN = 3dV	9	pF	
Cout ⁽³⁾	Output Capacitance	Vout = 3dV	10	pF	

NOTES:

1. These parameters are determined by device characterization, but are not production tested.

2. 3dV references the interpolated capacitance when the input and output switch from OV to 3V or from 3V to 0V.

3. COUT also references CI/O

Industrial and Commercial Temperature Ranges

DC Electrical Characteristics Over the Operating Temperature and Supply Voltage Range (V_{DD} = 3.3V ± 0.3V)

			70V91	69/59L	
Symbol	Parameter	Test Conditions	Min.	Мах.	Unit
LL	Input Leakage Current ⁽¹⁾	$V_{DD} = 3.6V$, $V_{IN} = 0V$ to V_{DD}		5	μA
Ilo	Output Leakage Current	\overline{CE} = VIH or CE1 = VIL, VOUT = 0V to VDD	-	5	μA
Vol	Output Low Voltage	IoL = +4mA	_	0.4	V
Vон	Output High Voltage	IOH = -4mA	2.4		V

NOTE:

1. At VDD \leq 2.0V input leakages are undefined.

DC Electrical Characteristics Over the Operating Temperature Supply Voltage Range $^{(3)}$ (V_DD = 3.3V \pm 0.3V)

						69/59L6 I Only		69/59L7 & Ind		59/59L9 Only	
Symbol	Parameter	Test Condition	Versio	n	Тур. ⁽⁴⁾	Мах.	Тур. ⁽⁴⁾	Max.	Тур. ⁽⁴⁾	Max.	Unit
ldd	Dynamic Operating	CEL and CER= VIL,	COM'L	L	175	330	155	280	135	230	mA
	Current (Both Ports Active)	Outputs Disabled, $f = fMAX^{(1)}$	IND	L			155	330			
ISB1	Standby Current	$\overline{CE}L = \overline{CE}R = VIH$	COM'L	L	50	80	40	70	30	60	mA
	(Both Ports - TTL Level Inputs)	$f = fMAX^{(1)}$	IND	L			40	80			
ISB2	Standby		COM'L	L	115	185	105	170	95	155	mA
	Current (One Port - TTL Level Inputs)	$\overline{CE}^{"B"} = VH^{(5)}$ Active Port Outputs Disabled, f=fMAX ⁽¹⁾	IND	L			105	180			
ISB3	Full Standby	Both Ports CEL and	COM'L	L	0.5	3.0	0.5	3.0	0.5	3.0	mA
	Current (Both Ports - CMOS Level Inputs)	$\label{eq:certain} \begin{split} \overline{CE} R \ge & V \text{dd} - 0.2 V, \\ V \text{IN} \ge & V \text{dd} - 0.2 V \text{ or} \\ V \text{IN} \le & 0.2 V, \ f = & 0^{(2)} \end{split}$	IND	L			0.5	3.0			
ISB4	Full Standby	\overline{CE} "A" $\leq 0.2V$ and	COM'L	L	105	175	95	160	85	145	mA
	Current (One Port - CMOS Level Inputs)	$\begin{array}{l} \overline{\text{CE}"}\text{B"} & \geq \text{V}_{\text{DD}} - 0.2\text{V}^{(5)} \\ \overline{\text{V}}\text{N} & \geq \text{V}_{\text{DD}} - 0.2\text{V or} \\ \overline{\text{V}}\text{N} & \leq 0.2\text{V}, \text{ Active Port,} \\ \overline{\text{Outputs Disabled}}, \text{f} = \text{fmAx}^{(1)} \end{array}$	IND	L	_		95	175		_	

NOTES:

1. At f = fMAX, address and control lines (except Output Enable) are cycling at the maximum frequency clock cycle of 1/tcyc, using "AC TEST CONDITIONS" at input levels of GND to 3V.

2. f = 0 means no address, clock, or control lines change. Applies only to input at CMOS level standby.

3. Port "A" may be either left or right port. Port "B" is the opposite from port "A".

4. VDD = 3.3V, TA = 25°C for Typ, and are not production tested. Icc bc(f=0) = 90mA (Typ).

5. $\overline{CE}x = VIL$ means $\overline{CE}ox = VIL$ and CE1x = VIH

 $\overline{CE}x = VIH$ means $\overline{CE}ox = VIH$ or CE1x = VIL

 $\overline{CE}x \leq 0.2V$ means $\overline{CE}\textsc{ox} \leq 0.2V$ and CE1x \geq VDD - 0.2V

 $\overline{\text{CE}} x \geq \text{ VDD - 0.2V means } \overline{\text{CE}} \text{ox} \geq \text{ VDD - 0.2V or CE1x} \leq 0.2\text{V}$

"X" represents "L" for left port or "R" for right port.

5655 tbl 08

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High-Speed 3.3V 16/8K x 9 Dual-Port Synchronous Pipelined Static RAM

Industrial and Commercial Temperature Ranges

AC Test Conditions

Input Pulse Levels	GND to 3.0V
Input Rise/Fall Times	2ns Max.
Input Timing Reference Levels	1.5V
Output Reference Levels	1.5V
Output Load	Figures 1, 2 & 3





Figure 1. AC Output Test load.





Figure 3. Typical Output Derating (Lumped Capacitive Load).

High-Speed 3.3V 16/8K x 9 Dual-Port Synchronous Pipelined Static RAM

AC Electrical Characteristics Over the Operating Temperature Range (Read and Write Cycle Timing)⁽³⁾ (V_{DD} = 3.3V ± 0.3V, TA = 0°C to +70°C)

			69/59L6 I Only		69/59L7 & Ind	70V9169/59L9 Com'l Only		
Symbol	Parameter	Min.	Max.	Min.	Max.	Min.	Max.	Unit
tcyc1	Clock Cycle Time (Flow-Through) ⁽²⁾	19	—	22		25	—	ns
tcyc2	Clock Cycle Time (Pipelined) ⁽²⁾	10	—	12		15	—	ns
tCH1	Clock High Time (Flow-Through) ⁽²⁾	6.5		7.5		12		ns
tal1	Clock Low Time (Flow-Through) ⁽²⁾	6.5	—	7.5		12	—	ns
tCH2	Clock High Time (Pipelined) ⁽²⁾	4	—	5		6	—	ns
tal2	Clock Low Time (Pipelined) ⁽²⁾	4	—	5		6	—	ns
tR	Clock Rise Time		3		3		3	ns
tr	Clock Fall Time		3		3		3	ns
tsa	Address Setup Time	3.5		4		4		ns
tha	Address Hold Time	0		0		1	—	ns
tsc	Chip Enable Setup Time	3.5		4		4		ns
thc	Chip Enable Hold Time	0		0		1		ns
tsв	Byte Enable Setup Time	3.5	—	4		4	—	ns
tнв	Byte Enable Hold Time	0		0		1		ns
tsw	R/W Setup Time	3.5		4		4		ns
tHW	R/\overline{W} Hold Time	0	—	0		1	—	ns
tsp	Input Data Setup Time	3.5		4		4		ns
thd	Input Data Hold Time	0	—	0		1	—	ns
tsad	ADS Setup Time	3.5	—	4		4	—	ns
thad	ADS Hold Time	0		0		1		ns
tscn	CNTEN Setup Time	3.5		4		4		ns
thon	CNTEN Hold Time	0		0		1		ns
t SRST	CNTRST Setup Time	3.5		4		4		ns
thrst	CNTRST Hold Time	0		0		1		ns
toe	Output Enable to Data Valid		6.5		7.5		9	ns
tolz	Output Enable to Output Low-Z ⁽¹⁾	2		2		2	—	ns
toнz	Output Enable to Output High-Z ⁽¹⁾	1	7	1	7	1	7	ns
tCD1	Clock to Data Valid (Flow-Through) ⁽²⁾		15		18		20	ns
tCD2	Clock to Data Valid (Pipelined) ⁽²⁾		6.5		7.5		9	ns
tDC	Data Output Hold After Clock High	2		2		2		ns
tскнz	Clock High to Output High-Z ⁽¹⁾	2	9	2	9	2	9	ns
tск⊥z	Clock High to Output Low-Z ⁽¹⁾	2		2		2	—	ns
Port-to-Port I		•					•	•
tcwdd	Write Port Clock High to Read Data Delay		24	—	28	—	35	ns
toos	Clock-to-Clock Setup Time		9		10		15	ns

1. Transition is measured 0mV from Low or High-impedance voltage with the Output Test Load (Figure 2). This parameter is guaranteed by device characterization, but is not production tested.

2. The Pipelined output parameters (tcvc2, tcb2) apply to either or both the Left and Right ports when FT/PIPE = VIH. Flow-through parameters (tcvc1, tcb1) apply when FT/PIPE = VIL for that port.

3. All input signals are synchronous with respect to the clock except for the asynchronous Output Enable (OE), FT/PIPER, and FT/PIPEL.

Timing Waveform of Read Cycle for Flow-Through Output $(\mathbf{FT}/PIPE^{*}X^{*} = VIL)^{(3,6)}$



Timing Waveform of Read Cycle for Pipelined Operation $(FT/PIPE"x" = VIH)^{(3,6)}$



- 1. Transition is measured 0mV from Low or High-impedance voltage with the Output Test Load (Figure 2).
- 2. OE is asynchronously controlled; all other inputs are synchronous to the rising clock edge.
- 3. $\overline{ADS} = VIL$, \overline{CNTEN} and $\overline{CNTRST} = VIH$.
- 4. The output is disabled (High-Impedance state) by $\overline{CE}_0 = V_{IH}$, CE1 = VIL following the next rising edge of the clock. Refer to Truth Table 1.
- 5. Addresses do not have to be accessed sequentially since ADS = VIL constantly loads the address on the rising edge of the CLK; numbers
- are for reference use only.6. "X' here denotes Left or Right port. The diagram is with respect to that port.

Industrial and Commercial Temperature Ranges

Timing Waveform of a Bank Select Pipelined Read^(1,2)



Timing Waveform with Port-to-Port Flow-Through Read^(4,5,7)



- 1. B1 Represents Bank #1; B2 Represents Bank #2. Each Bank consists of one IDT70V916/59L for this waveform, and are setup for depth expansion in this example. ADDRESS(B1) = ADDRESS(B2) in this situation.
- 2. $\overline{\text{OE}}$ and $\overline{\text{ADS}}$ = VIL; $\overline{\text{CE1(B1)}}$, $\overline{\text{CE1(B2)}}$, $\overline{\text{R/W}}$, $\overline{\text{CNTEN}}$, and $\overline{\text{CNTRST}}$ = VIH.
- 3. Transition is measured OmV from Low or High-impedance voltage with the Output Test Load (Figure 2).
- 4. \overline{CE}_0 and $\overline{ADS} = VIL$; CE1, \overline{CNTEN} , and $\overline{CNTRST} = VIH$.
- 5. \overline{OE} = V_{IL} for the Right Port, which is being read from. \overline{OE} = V_{IH} for the Left Port, which is being written to.
- 6. If tccs ≤ maximum specified, then data from right port READ is not valid until the maximum specified for tcwpp.
- If tccs > maximum specified, then data from right port READ is not valid until tccs + tcp1. tcwpb does not apply in this case.
- 7. All timing is the same for both Left and Right ports. Port "A" may be either Left or Right port. Port "B" is the opposite from Port "A".

Timing Waveform of Pipelined Read-to-Write-to-Read ($\overline{OE} = VIL$)⁽³⁾



Timing Waveform of Pipelined Read-to-Write-to-Read (**OE** Controlled)⁽³⁾



- 1. Transition is measured 0mV from Low or High-impedance voltage with the Output Test Load (Figure 2).
- 2. Output state (High, Low, or High-impedance) is determined by the previous cycle control signals.
- 3. TEo and ADS = VIL; CE1, CNTEN, and CNTRST = VIH. "NOP" is "No Operation".
- 4. Addresses do not have to be accessed sequentially since ADS = ViL constantly loads the address on the rising edge of the CLK; numbers are for reference use only.
- 5. "NOP" is "No Operation." Data in memory at the selected address may be corrupted and should be re-written to guarantee data integrity.

Timing Waveform of Flow-Through Read-to-Write-to-Read ($\overline{OE} = VIL$)⁽³⁾



Timing Waveform of Flow-Through Read-to-Write-to-Read (**OE** Controlled)⁽³⁾



- 1. Transition is measured 0mV from Low or High-impedance voltage with the Output Test Load (Figure 2).
- 2. Output state (High, Low, or High-impedance) is determined by the previous cycle control signals.
- 3. \overline{CE}_0 and $\overline{ADS} = V_{IL}$; \overline{CE}_1 , \overline{CNTEN} , and $\overline{CNTRST} = V_{IH}$. "NOP" is "No Operation". 4. Addresses do not have to be accessed sequentially since $\overline{ADS} = V_{IL}$ constantly loads the address on the rising edge of the CLK; numbers are for reference use only.
- 5. "NOP" is "No Operation." Data in memory at the selected address may be corrupted and should be re-written to guarantee data integrity.

Timing Waveform of Pipelined Read with Address Counter Advance⁽¹⁾



Timing Waveform of Flow-Through Read with Address Counter Advance⁽¹⁾



NOTES:

1. \overline{CE}_0 and $\overline{OE} = V_{IL}$; CE1, R/W, and $\overline{CNTRST} = V_{IH}$.

2. If there is no address change via ADS = VIL (loading a new address) or CNTEN = VIL (advancing the address), i.e. ADS = VIH and CNTEN = VIH, then the data output remains constant for subsequent clocks.

Timing Waveform of Write with Address Counter Advance (Flow-Through or Pipelined Outputs)⁽¹⁾



Timing Waveform of Counter Reset (Pipelined Outputs)⁽²⁾



- 2. $\overline{CE}_0 = VIL; CE_1 = VIH.$
- 3. The "Internal Address" is equal to the "External Address" when ADS = VIL and equals the counter output when ADS = VIH.
- 4. Addresses do not have to be accessed sequentially since ADS = VIL constantly loads the address on the rising edge of the CLK; numbers are for reference use only.
- 5. Output state (High, Low, or High-impedance) is determined by the previous cycle control signals.
- 6. No dead cycle exists during counter reset. A READ or WRITE cycle may be coincidental with the counter reset cycle. ADDRo will be accessed. Extra cycles are shown here simply for clarification.
- 7. CNTEN = VIL advances Internal Address from 'An' to 'An +1'. The transition shown indicates the time required for the counter to advance. The 'An +1' Address is written to during this cycle.

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High-Speed 3.3V 16/8K x 9 Dual-Port Synchronous Pipelined Static RAM

Functional Description

The IDT70V9169/59 provides a true synchronous Dual-Port Static RAM interface. Registered inputs provide minimal set-up and hold times on address, data, and all critical control inputs. All internal registers are clocked on the rising edge of the clock signal, however, the self-timed internal write pulse is independent of the LOW to HIGH transition of the clock signal.

An asynchronous output enable is provided to ease asynchronous bus interfacing. Counter enable inputs are also provided to stall the operation of the address counters for fast interleaved memory applications.

 $\overline{CE}_0 = VIL \text{ and } CE_1 = VIH \text{ for one clock cycle will power down the internal circuitry to reduce static power consumption. Multiple chip enables allow easier banking of multiple IDT70V9169/59's for depth expansion configurations. When the Pipelined output mode is enabled, two cycles are required with <math>\overline{CE}_0 = VIL$ and $CE_1 = VIH$ to re-activate the outputs.

Depth and Width Expansion

The IDT70V9169/59 features dual chip enables (refer to Truth Table I) in order to facilitate rapid and simple depth expansion with no requirements for external logic. Figure 4 illustrates how to control the various chip enables in order to expand two devices in depth.

The IDT70V9169/59 can also be used in applications requiring expanded width, as indicated in Figure 4. Since the banks are allocated at the discretion of the user, the external controller can be set up to drive the input signals for the various devices as required to allow for 36-bit or wider applications.



NOTE:

1. A14 is for IDT70V9169, A13 is for IDT70V9159.

70V9169/59L High-Speed 3.3V 16/8K x 9 Dual-Port Synchronous Pipelined Static RAM Industrial and Commercial Temperature Ranges Ordering Information								
XXXXX	A	99	A	А	А	А		
Device Type	Power	Speed	Package		Process/ Temperature Range		Blank	Tube or Tray Tape and Reel
							Blank	Commercial (0°C to +70°C) Industrial (-40°C to +85°C)
							G ⁽²⁾	Green
							PF BF	100-pin TQFP (PN100) 100-pin fpBGA (BF100)
							6 7 9	Commercial Only Commercial & Industrial Commercial Only
							L	Low Power
							70V9169 70V9159	144K (16K x 9-Bit) Synchronous Dual-Port RAM 72K (8K x 9-Bit) Synchronous Dual-Port RAM

5655 drw 20

5638 tbl 12

NOTES:

 $1.\ Contact your local sales office for Industrial temp range for other speeds, packages and powers.$

2. Green parts available. For specific speeds, packages and powers see your sales office. LEAD FINISH (SnPb) parts are Obsolete. Product Discontinuation Notice - PDN# SP-17-02

Note that information regarding recently obsoleted parts is included in this datasheet for customer convenience.

IDT Clock Solution for IDT70V9169/59 Dual-Port

IDT Dual-Port Part Number	Dual-Port I/O	Specitications		Clock Specif	IDT	IDT		
	Voltage	I/O	Input Capacitance	Input Duty Cycle Requirement	Maximum Frequency	Jitter Tolerance	PLL Clock Device	Non-PLL Clock Device
70V9169/59	3.3	LVTTL	9pF	40%	100	150ps	IDT2305 IDT2308 IDT2309	FCT3805 FCT3805D/E FCT3807 FCT3807D/E

Datasheet Document History

07/08/02:	Initial Public Release
08/15/03:	Removed Preliminary status
	Page 16 Added IDT Clock Solution Table
01/29/09:	Page 16 Removed "IDT" from orderable part number
06/18/15:	Page 2 Removed IDT with reference to fabrication
	Page 2 Removed date from 100-pin TQFP configuration
	Page 2 & 16 The package code PN100-1 changed to PN100 to match standard package codes
	Page 3 Removed date from 100-pin fpBGA configuration
	Page 6 Corrected typo in the Typical Output Derating drawing
	Page 16 Added Tape and Reel and Green indicators and updated the footnotes to the Ordering Information
	Product Discontinuation Notice - PDN# SP-17-02
02/21/18:	Last time buy expires June 15, 2018
04/22/19:	70V9159 is obsolete
	70V9169 is still active

CORPORATE HEADQUARTERS



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